



SamHop Microelectronics Corp.



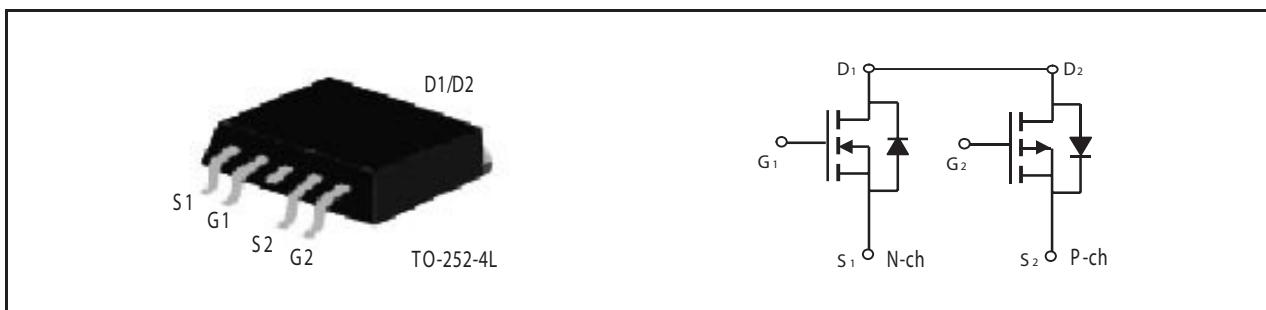
STU612D

Ver 1.0

Dual Enhancement Mode Field Effect Transistor (N and P Channel)

PRODUCT SUMMARY (N-Channel)		
V _{DSS}	ID	R _{DSON} (mΩ) Max
60V	8.6A	76 @ V _{GS} =10V
		90 @ V _{GS} =4.5V

PRODUCT SUMMARY (P-Channel)		
V _{DSS}	ID	R _{DSON} (mΩ) Max
-60V	-7.3A	110 @ V _{GS} =-10V
		145 @ V _{GS} =-4.5V



ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	N-Channel	P-Channel	Units	
V _{DS}	Drain-Source Voltage	60	-60	V	
V _{GS}	Gate-Source Voltage	± 20	± 20	V	
I _D	Drain Current-Continuous ^a	T _C =25°C	8.6	-7.3	A
		T _C =70°C	6.9	-5.8	A
I _{DM}	-Pulsed ^b	25	-21	A	
E _{AS}	Sigle Pulse Avalanche Energy ^d	20	30	mJ	
P _D	Maximum Power Dissipation ^a	T _C =25°C	10.5	W	
		T _C =70°C	6.7	W	
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150		°C	

THERMAL CHARACTERISTICS

R _θ JC	Thermal Resistance, Junction-to-Case ^a	12	°C/W
R _θ JA	Thermal Resistance, Junction-to-Ambient ^a	60	°C/W

Details are subject to change without notice.

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N-Channel ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	60			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=48\text{V}$, $V_{GS}=0\text{V}$			1	μA
I _{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$			± 100	nA
ON CHARACTERISTICS						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	1.0	1.6	3	V
R _{D(S(ON))}	Drain-Source On-State Resistance	$V_{GS}=10\text{V}$, $I_D=8.6\text{A}$		60	76	m ohm
		$V_{GS}=4.5\text{V}$, $I_D=8\text{A}$		70	90	m ohm
g _{FS}	Forward Transconductance	$V_{DS}=5\text{V}$, $I_D=8.6\text{A}$		21		S
DYNAMIC CHARACTERISTICS ^c						
C _{ISS}	Input Capacitance	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$ $f=1.0\text{MHz}$		850		pF
C _{OSS}	Output Capacitance			48		pF
C _{RSS}	Reverse Transfer Capacitance			40		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	$V_{DD}=30\text{V}$ $I_D=1\text{A}$ $V_{GS}=10\text{V}$ $R_{GEN}=3.3\text{ ohm}$		11.5		ns
t _r	Rise Time			11.7		ns
t _{D(OFF)}	Turn-Off Delay Time			37		ns
t _f	Fall Time			7		ns
Q _g	Total Gate Charge	$V_{DS}=30\text{V}, I_D=8.6\text{A}, V_{GS}=10\text{V}$		17		nC
		$V_{DS}=30\text{V}, I_D=8.6\text{A}, V_{GS}=4.5\text{V}$		8.3		nC
Q _{gs}	Gate-Source Charge	$V_{DS}=30\text{V}, I_D=8.6\text{A},$ $V_{GS}=10\text{V}$		1.7		nC
Q _{gd}	Gate-Drain Charge			4.7		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I _s	Maximum Continuous Drain-Source Diode Forward Current				2.0	A
V _{SD}	Diode Forward Voltage ^b	$V_{GS}=0\text{V}, I_s=2\text{A}$		0.81	1.2	V

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P-Channel ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=-250\mu\text{A}$	-60			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-48\text{V}$, $V_{\text{GS}}=0\text{V}$			-1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}= \pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$			± 100	nA
ON CHARACTERISTICS						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=-250\mu\text{A}$	-1.0	-1.7	-3	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-10\text{V}$, $I_{\text{D}}=-7.3\text{A}$		88	110	m ohm
		$V_{\text{GS}}=-4.5\text{V}$, $I_{\text{D}}=-6.3\text{A}$		110	145	m ohm
g_{FS}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$, $I_{\text{D}}=-7.3\text{A}$		12		S
DYNAMIC CHARACTERISTICS ^c						
C_{iss}	Input Capacitance	$V_{\text{DS}}=-30\text{V}$, $V_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$		740		pF
C_{oss}	Output Capacitance			64		pF
C_{rss}	Reverse Transfer Capacitance			38		pF
SWITCHING CHARACTERISTICS ^c						
$t_{\text{D}(\text{ON})}$	Turn-On Delay Time	$V_{\text{DD}}=-30\text{V}$ $I_{\text{D}}=-1\text{A}$ $V_{\text{GS}}=-10\text{V}$ $R_{\text{GEN}}=6\text{ ohm}$		12.5		ns
t_{r}	Rise Time			12		ns
$t_{\text{D}(\text{OFF})}$	Turn-Off Delay Time			65		ns
t_{f}	Fall Time			12		ns
Q_{g}	Total Gate Charge	$V_{\text{DS}}=-30\text{V}$, $I_{\text{D}}=-7.3\text{A}$, $V_{\text{GS}}=-10\text{V}$		13.5		nC
		$V_{\text{DS}}=-30\text{V}$, $I_{\text{D}}=-7.3\text{A}$, $V_{\text{GS}}=-4.5\text{V}$		6		nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=-30\text{V}$, $I_{\text{D}}=-7.3\text{A}$, $V_{\text{GS}}=-10\text{V}$		1.6		nC
Q_{gd}	Gate-Drain Charge			3.6		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I_{s}	Maximum Continuous Drain-Source Diode Forward Current			-1.6		A
V_{SD}	Diode Forward Voltage ^b	$V_{\text{GS}}=0\text{V}$, $I_{\text{s}}=-1.6\text{A}$		-0.8	-1.2	V
Notes						
a.Surface Mounted on FR4 Board, $t \leq 10\text{sec}$.						
b.Pulse Test:Pulse Width $\leq 300\text{us}$, Duty Cycle $\leq 2\%$.						
c.Guaranteed by design, not subject to production testing.						
d.Starting $T_J=25^\circ\text{C}$, $L=0.5\text{mH}$, $V_{\text{DD}}=30\text{V}$, $V_{\text{GS}}=10\text{V}$. (See Figure13)						

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N-Channel

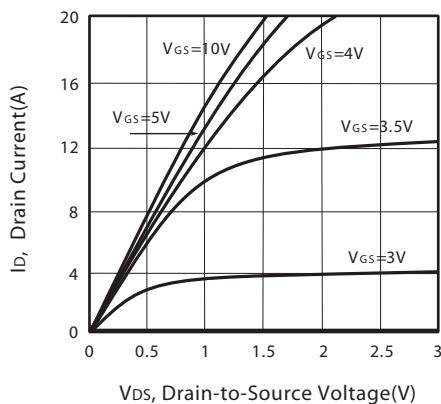


Figure 1. Output Characteristics

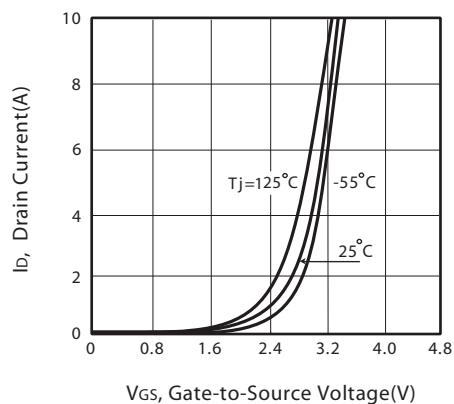


Figure 2. Transfer Characteristics

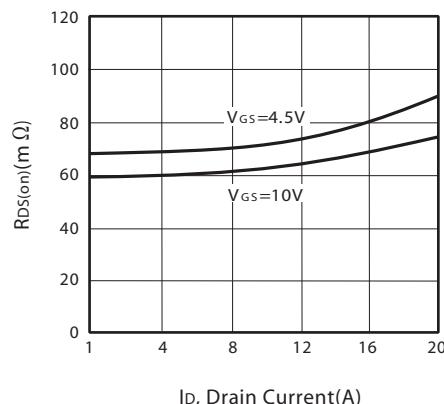


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

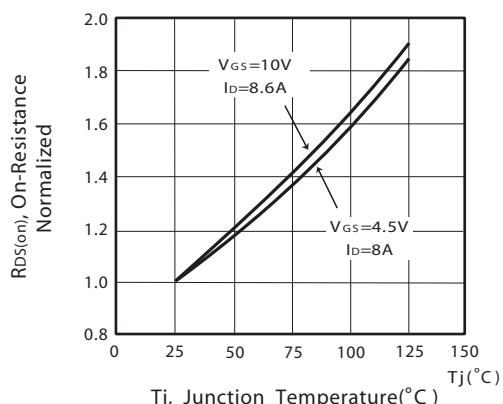


Figure 4. On-Resistance Variation with Drain Current and Temperature

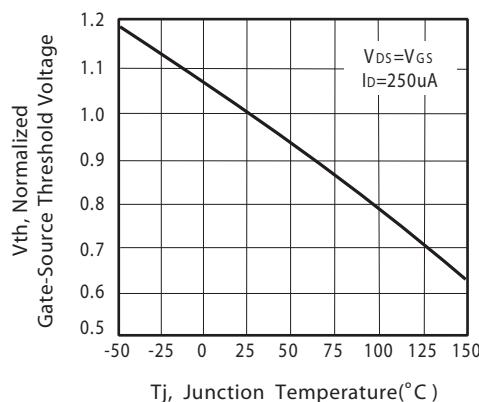


Figure 5. Gate Threshold Variation with Temperature

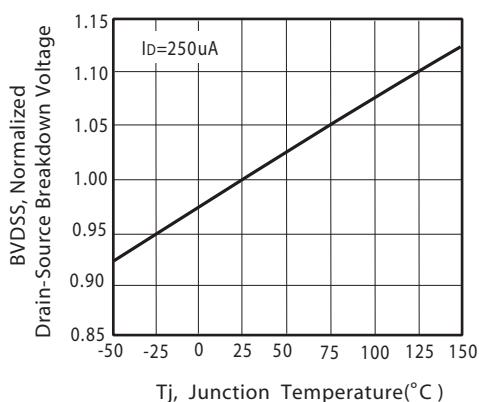


Figure 6. Breakdown Voltage Variation with Temperature

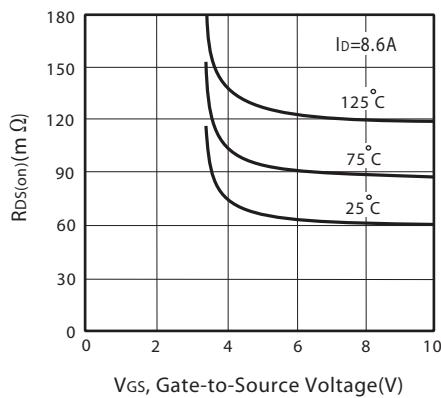


Figure 7. On-Resistance vs. Gate-Source Voltage

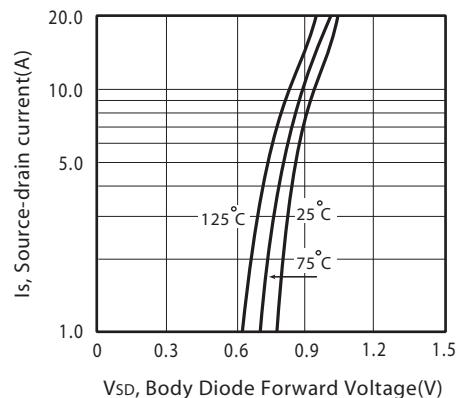


Figure 8. Body Diode Forward Voltage Variation with Source Current

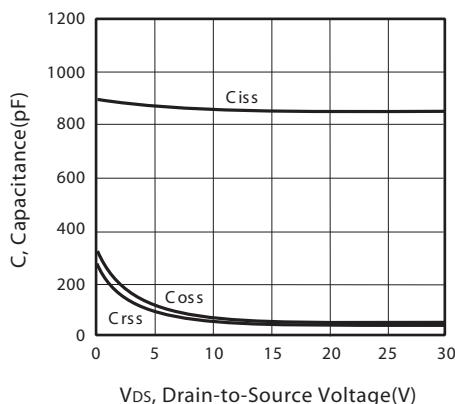


Figure 9. Capacitance

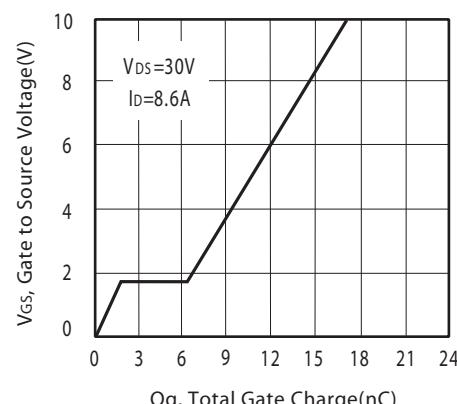


Figure 10. Gate Charge

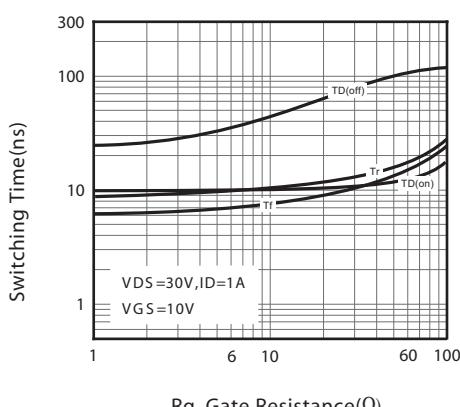


Figure 11. switching characteristics

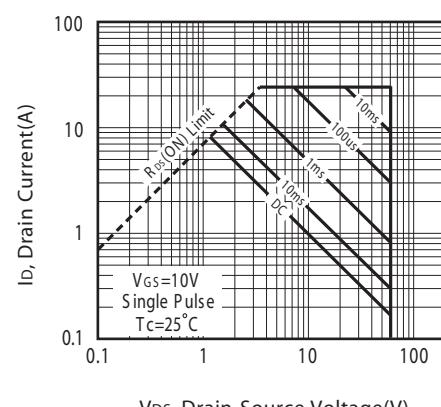
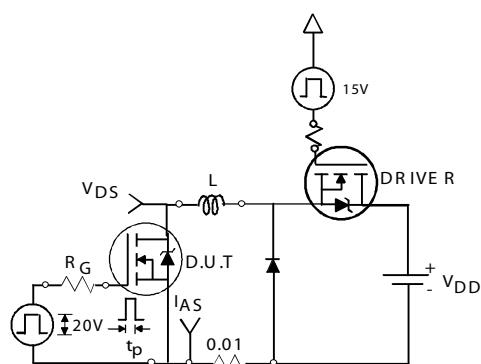


Figure 12. Maximum Safe Operating Area

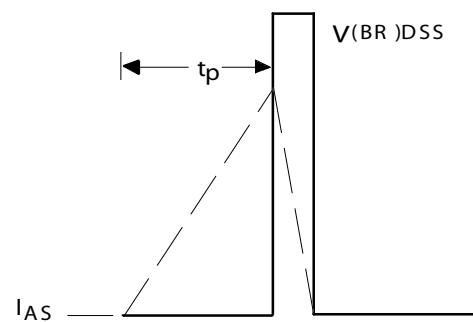
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

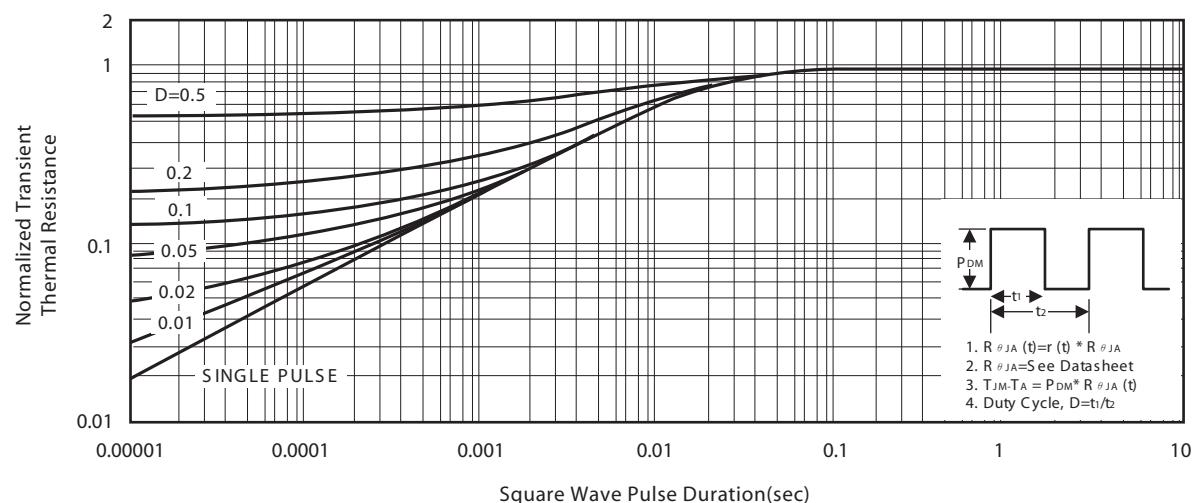


Figure 14. Normalized Thermal Transient Impedance Curve

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P-Channel

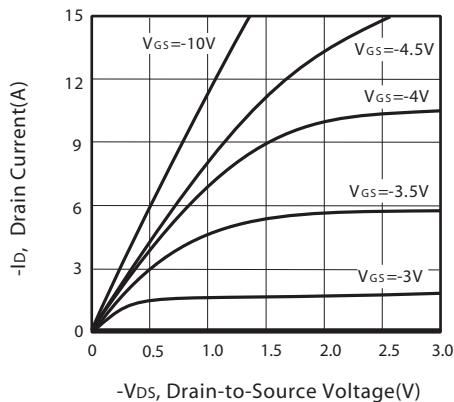


Figure 1. Output Characteristics

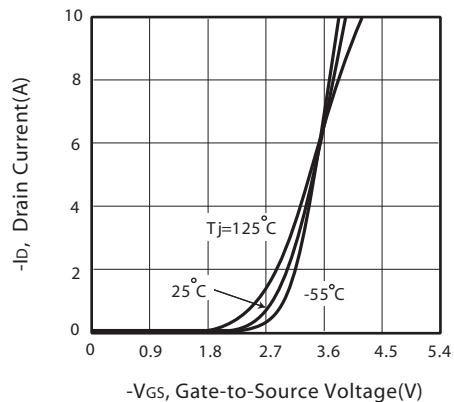


Figure 2. Transfer Characteristics

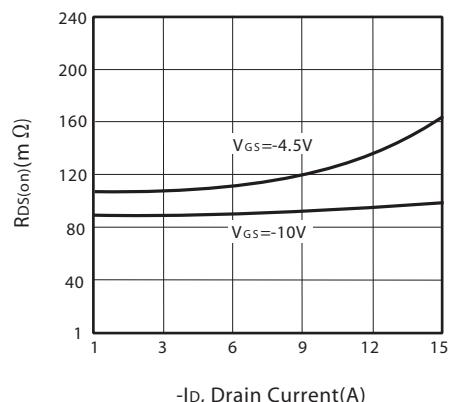


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

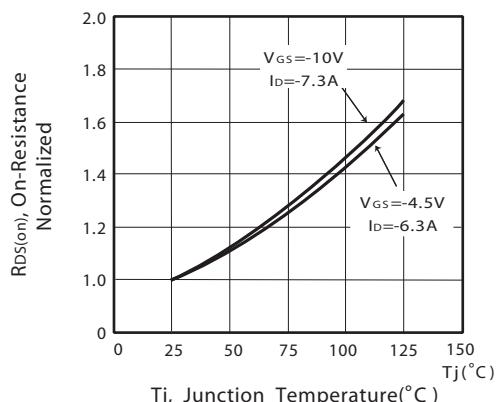


Figure 4. On-Resistance Variation with Drain Current and Temperature

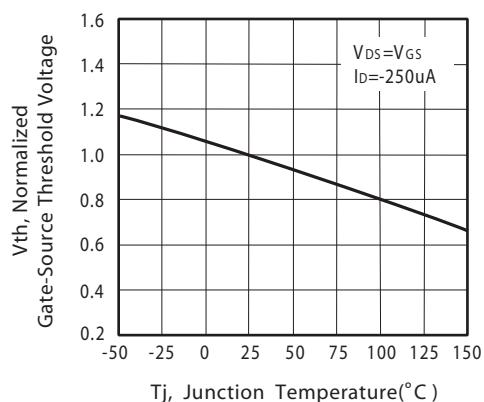


Figure 5. Gate Threshold Variation with Temperature

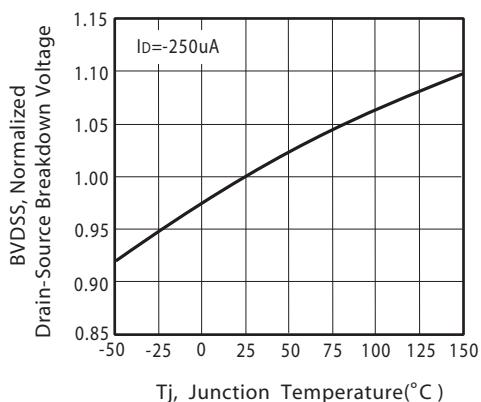


Figure 6. Breakdown Voltage Variation with Temperature

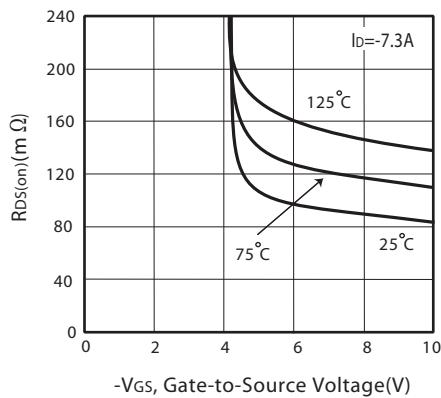


Figure 7. On-Resistance vs.
Gate-Source Voltage

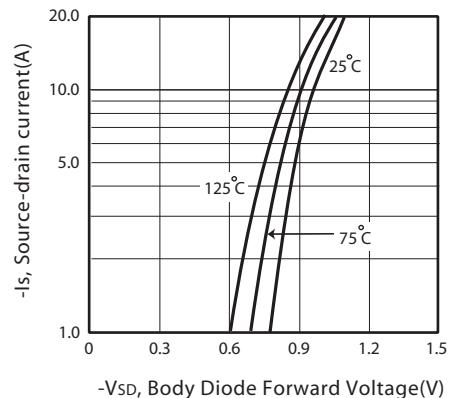


Figure 8. Body Diode Forward Voltage
Variation with Source Current

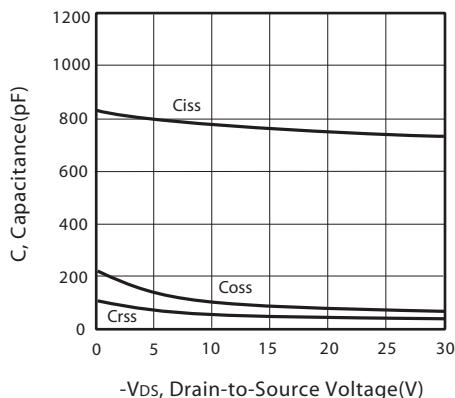


Figure 9. Capacitance

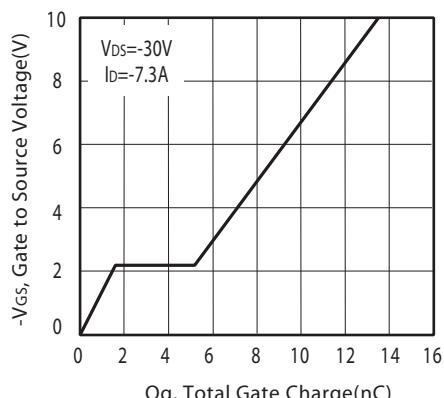


Figure 10. Gate Charge

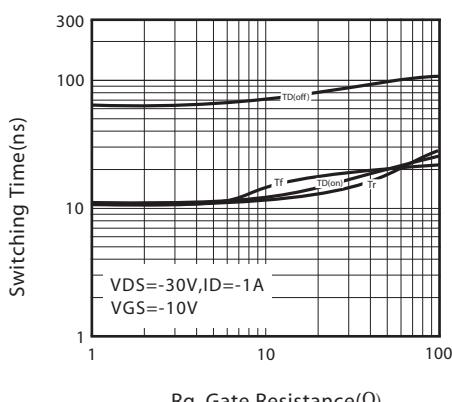


Figure 11. switching characteristics

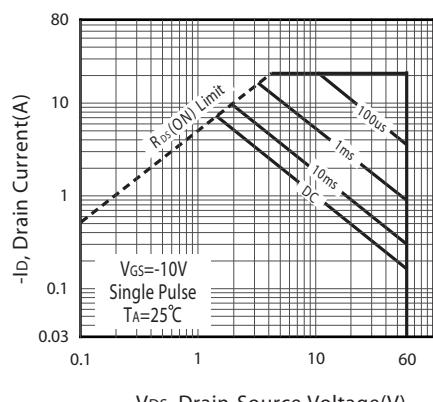
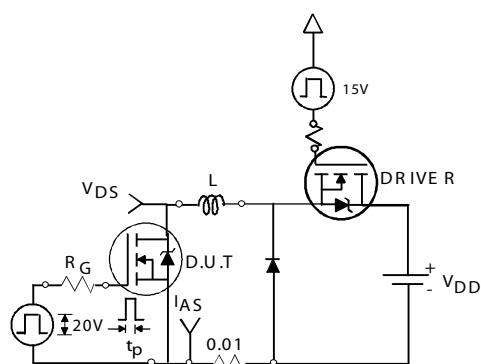


Figure 12. Maximum Safe Operating Area

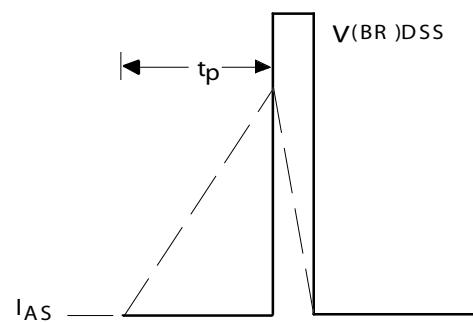
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

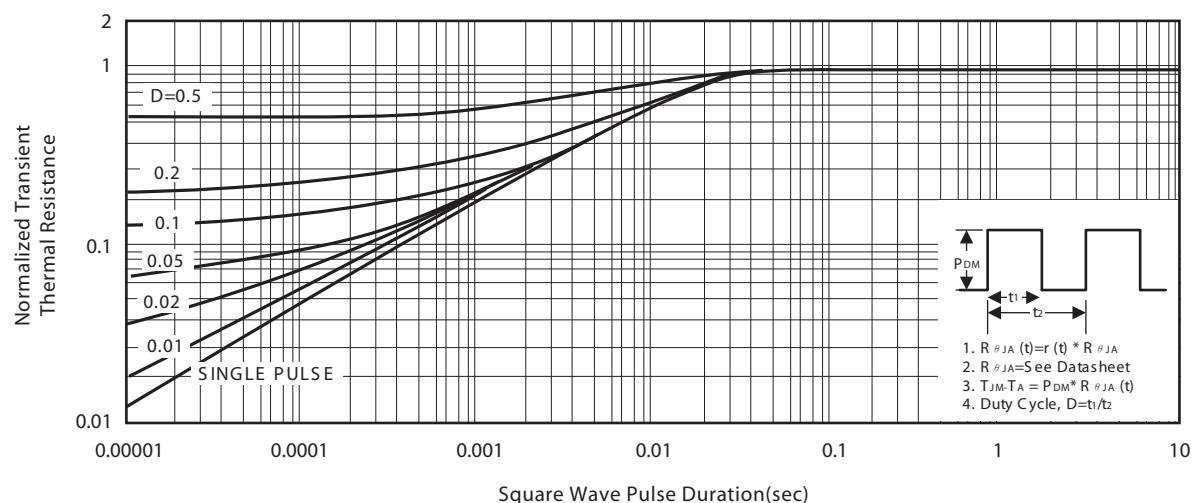
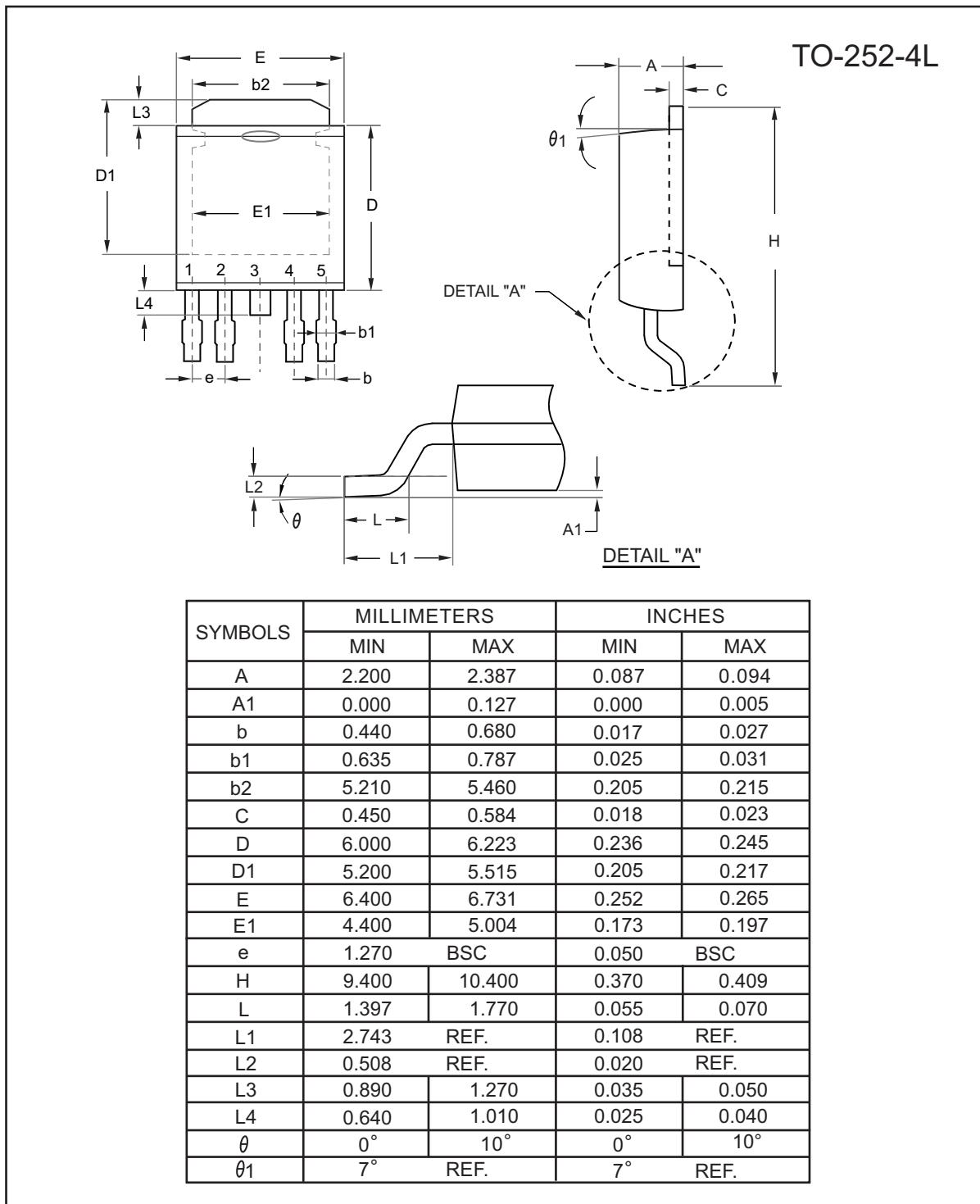


Figure 14. Normalized Thermal Transient Impedance Curve

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PACKAGE OUTLINE DIMENSIONS



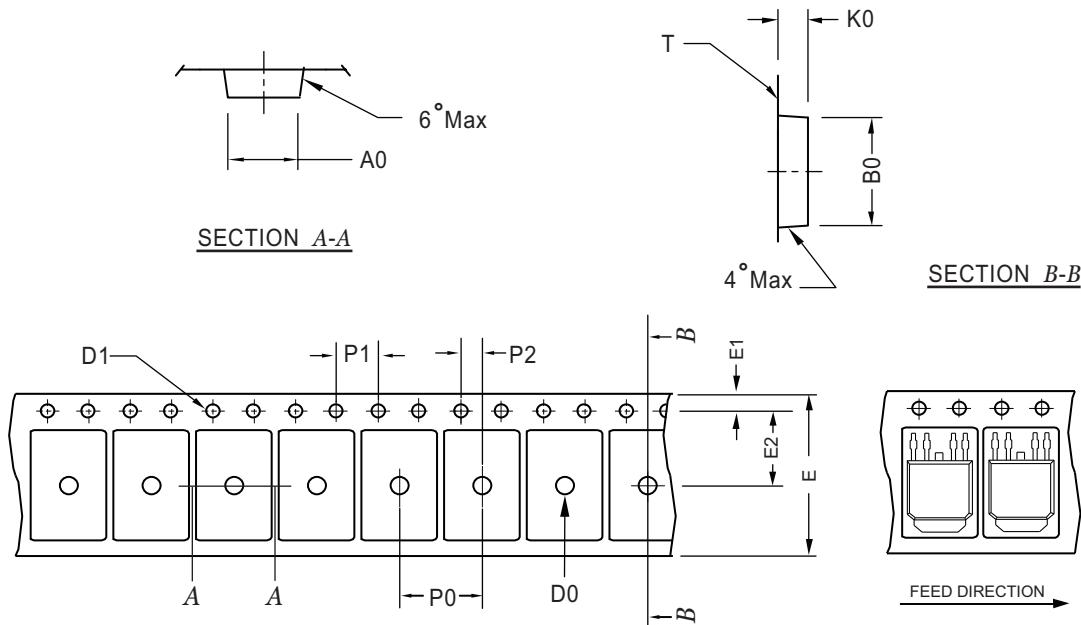
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TO-252-4L Tape and Reel Data

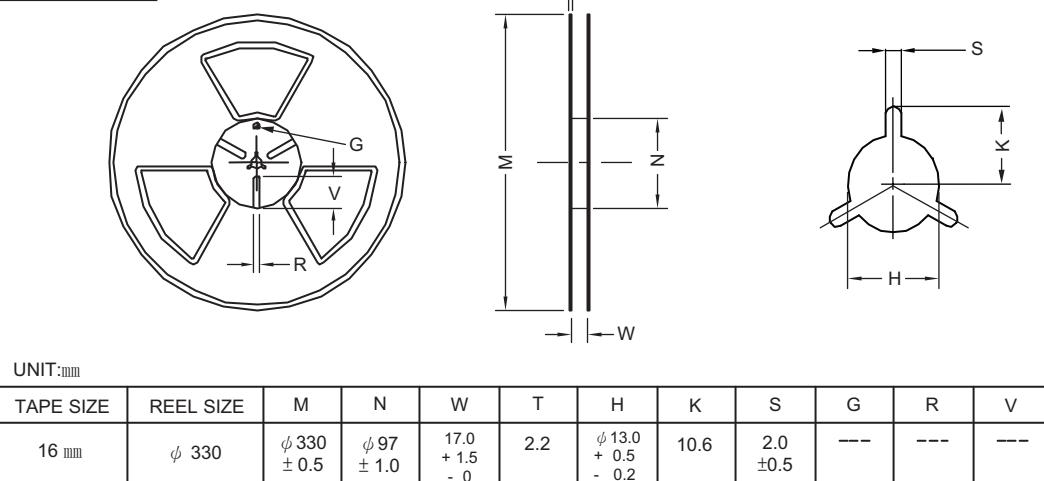
TO-252-4L Carrier Tape



UNIT:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
TO-252 (16 mm)	6.96 ±0.1	10.49 ±0.1	2.79 ±0.1	ϕ 2	ϕ 1.5 + 0.1 - 0	16.0 ±0.3	1.75 ±0.1	7.5 ±0.15	8.0 ±0.1	4.0 ±0.1	2.0 ±0.15	0.3 ±0.05

TO-252-4L Reel



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